

ISO²-CMOS MT9196 Integrated Digital Phone Circuit (IDPC)

Data Sheet

January 2006

Features

- Programmable m-Law/A-Law CODEC and Filters
- Programmable CCITT (G.711)/sign-magnitude coding
- Programmable transmit, receive and side-tone gains
- Digital DTMF and single tone generation
- Fully differential interface to handset transducers
- Auxiliary analog interface
- Interface to ST-BUS/SSI (compatible with GCI)
- Serial microport control
- Single 5 volt supply, low power operation
- Anti-howl circuit for group listening speakerphone applications

Applications

- Digital telephone sets
- Wireless telephones
- Local area communications stations

Ordering Information									
MT9196AP MT9196AS MT9196ASR MT9196ASR MT9196APR MT9196APR1 MT9196AP1 MT9196AS1 MT9196ASR1	28 Pin PLCC 28 Pin PDIP 28 Pin SOIC 28 Pin SOIC 28 Pin PLCC 28 Pin PDIP* 28 Pin PLCC* 28 Pin PLCC* 28 Pin SOIC* 28 Pin SOIC* Pb Free Matte Tin	Tubes Tubes Tape & Reel Tape & Reel Tubes Tape & Reel Tubes Tubes Tape & Reel							
	-40°C to +85°C								

Description

The MT9196 Integrated Digital Phone Circuit (IDPC) is designed for use in digital phone products. The device incorporates a built-in Filter/Codec, digital gain pads, DTMF generator and tone ringer. Complete telephony interfaces are provided for connecting to handset and speakerphone transducers. Internal register access is provided through a serial microport compatible with various industry standard micro-controllers.

The device is fabricated in Zarlink's ISO²-CMOS technology ensuring low power consumption and high reliability.



Figure 1 - Functional Block Diagram

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Pin Description

Pin #	Name	Description				
1	M-	Inverting Microphone (Input). Inverting input to microphone amplifier from the handset microphone.				
2	M+	Non-Inverting Microphone (Input). Non-inverting input to microphone amplifier from the handset microphone.				
3	V _{Bias}	Bias Voltage (Output). (V_{DD} /2) volts is available at this pin for biasing external amplifiers. Connect 0.1 μ F capacitor to V_{SSA} .				
4	V_{Ref}	Reference voltage for codec (Output). Nominally $[(V_{DD}/2)-1.5]$ volts. Used internally. Connect 0.1 μ F capacitor to V _{SSA} .				
5	PWRST	Power-up Reset (Input). CMOS compatible input with Schmitt Trigger (active low).				
6	IC	Internal Connection. Tie externally to V _{SS} for normal operation.				
7	V_{SSD}	Digital Ground. Nominally 0 volts.				
8	CS	Chip Select (Input). This input signal is used to select the device for microport data transfers. Active low. TTL level compatible.				
9	SCLK	Serial Port Synchronous Clock (Input). Data clock for microport. TTL level compatible.				
10	DATA1	Bidirectional Serial Data. Port for microprocessor serial data transfer. In Motorola/National mode of operation, this pin becomes the data transmit pin only and data receive is performed on the DATA2 pin. TTL level compatible input levels.				
11	DATA2	Serial Data Receive. In Motorola/National mode of operation, this pin is used for data receive to the IDPC. In Intel mode, serial data transmit and receive are performed on the DATA1 pin and DATA2 is disconnected. Input level TTL compatible.				
12	WD	Watchdog (Output). Watchdog timer output. Active high.				
13	IRQ	Interrupt Request (Open Drain Output). Low true interrupt output to microcontroller.				

Pin Description (continued)

Pin #	Name	Description
14	D _{out}	Data Output. A tri-state digital output for 8 bit wide channel data being sent to the Layer 1 device. Data is shifted out via this pin concurrent with the rising edge of BCL during the timeslot defined by STB, or according to standard ST-BUS timing.
15	D _{in}	Data Input. A digital input for 8 bit wide channel data received from the Layer 1 device. Data is sampled on the falling edge of BCL during the timeslot defined by STB, or according to standard ST-BUS timing. Input level is CMOS compatible.
16	STB/F0i	Data Strobe/Frame Pulse (Input). For SSI mode this input determines the 8 bit timeslot used by the device for both transmit and receive data. This active high signal has a repetition rate of 8 kHz. Standard frame pulse definitions apply in ST-BUS mode. CMOS level compatible input.
17	CLOCKin	Clock Input. The clock provided to this input is used by the internal phone functions. In ST-BUS mode this is the C4i input. In SSI synchronous mode, this is the Bit Clock input. In SSI-asynchronous mode this is an asynchronous 4 MHz Master Clock input.
18	XSTL2	Crystal Input (4.096 MHz). Used in conjunction with the CLOCKin pin to provide the master clock signal via external crystal.
19	V _{DD}	Positive Power Supply (Input). Nominally 5 volts.
20	HSPKR-	Inverting Handset Speaker (Output). Output to the handset speaker (balanced).
21	HSPKR+	Non-Inverting Handset Speaker (Output). Output to the handset speaker (balanced).
22	SPKR-	Inverting Speaker (Output). Output to the speakerphone speaker (balanced).
23	SPKR+	Non-Inverting Speaker (Output). Output to the speakerphone speaker (balanced).
24	$V_{SS}SPKR$	Power Supply Rail for Speaker Driver. Nominally 0 Volts.
25	AUX _{out}	Auxiliary Port (Output). Access point to the D/A (analog) signals of the receive path as well as to the various analog inputs.
26	AUX _{in}	Auxiliary Port (Input). An analog signal may be fed to the filter/codec transmit section and various loopback paths via this pin. No external anti-aliasing is required.
27	MIC+	Non-inverting on-hook answer back Microphone (Input). Microphone amplifier non- inverting input pin.
28	V _{SSA}	Analog Ground (Input). Nominally 0 V.

Overview

The functional block diagram of Figure 1 depicts the main operations performed by the MT9196 IDPC. Each of these functional blocks will be described individually in the sections to follow. This overview will describe some of the end-user features which may be implemented as a direct result of the level of integration found within the IDPC.

The main feature required of a digital telephone is to convert the digital Pulse Code Modulated (PCM) information, being received by the telephone set, into an analog electrical signal. This signal is then applied to an appropriate audio transducer such that the information is finally converted into intelligible acoustic energy. The same is true of the reverse direction where acoustic energy is converted first into an electrical analog and then digitized (into PCM) before being transmitted from the set. Along the way if the signals can be manipulated, either in the analog or the digital domains, other features such as gain control and signal generation may be added. Finally, most electro-acoustic transducers (loudspeakers) require a large amount of power if they are to develop an acoustic signal. The inclusion of audio amplifiers to provide this power is required.

The IDPC features complete Analog/Digital and Digital/Analog conversion of audio signals (Filter/CODEC) and an analog interface to electro-acoustic devices (Transducer Interface). Full programmability of the receive path and side-tone gains is available to set comfortable listening levels for the user. Transmit path gain control is available for setting nominal transmit levels into the network. A digital, anti-feedback circuit permits both the handset microphone and the speaker-phone speaker to be enabled at the same time for group listening applications. This anti-feedback circuit limits the total loop gain there by preventing a singing condition from developing.

Signalling in digital telephone systems, behind the PBX or standard ISDN applications, is handled on the D-channel and generally does not require DTMF tones. Locally generated tones, in the set, however, can be used to provided "comfort tones" or "key confirmation" to the user, similar to the familiar DTMF tones generated by conventional phones during initial call set-up. Also, as the network slowly evolves from the dial pulse/DTMF methods to the D-Channel protocols it is essential that the older methods be available for backward compatibility. As an example, once a call has been established (i.e., from your office to your home) using the D-Channel signalling protocol it may be necessary to use in-band DTMF signalling to manipulate your personal answering machine in order to retrieve messages. Thus the locally generated tones must be of network quality. The IDPC can generate the required tone pairs as well as single tones to accommodate any in-band signalling requirement.

Each of the programmable parameters within the functional blocks is accessed through a serial microcontroller port compatible with Intel MCS-51[®], Motorola SPI[®] and National Semiconductor Microwire[®] specifications.

Functional Description

In this section each of the functional blocks within IDPC is described along with all of the associated control/status bits. Each time a control/status bit(s) is described it is followed by the address register where it will be found. The reader is referred to the section titled 'Register Summary' for a complete listing of all address registers, the control/status bits associated with each register and a definition of the function of each control/status bit. The Register Summary is useful for future reference of control/status bits without the need to locate them in the text of the functional descriptions.

Filter/CODEC

The Filter/CODEC block implements conversion of the analog 3.3 kHz speech signals to/from the digital domain compatible with 64 kb/s PCM B-Channels. Selection of companding curves and digital code assignment are register programmable. These are CCITT G.711 A-law or μ -Law, with true-sign/ Alternate Digit Inversion or true-sign/Inverted Magnitude coding, respectively. Optionally, sign- magnitude coding may also be selected for proprietary applications.

The Filter/CODEC block also implements transmit and receive audio path gains in the analog domain. These gains are in addition to the digital gain pad section and provide an overall path gain resolution of 1.0 dB. A programmable gain, voice side-tone path is also included to provide proportional transmit speech feedback to the handset receiver. Figure 3 depicts the nominal half-channel and side-tone gains for the IDPC.

On \overline{PWRST} (pin 5) the Filter/CODEC defaults such that the side-tone path, dial tone filter and 400 Hz transmit filter are off, all programmable gains are set to 0 dB and CCITT μ -Law is selected. Further, the Filter/CODEC is powered down due to the control bits of the Path Control Registers (addresses 12h and 13h) being reset.

The internal architecture is fully differential to provide the best possible noise rejection as well as to allow a wide dynamic range from a single 5 volt supply design. This fully differential architecture is continued into the Transducer Interface section to provide full chip realization of these capabilities for the handset and loudspeaker functions.

A reference voltage (V_{Ref}), for the conversion requirements of the CODEC section, and a bias voltage (V_{Bias}), for biasing the internal analog sections, are both generated on-chip. V_{Bias} is also brought to an external pin so that it may be used for biasing external gain plan setting amplifiers. A 0.1 μ F capacitor must be connected from V_{Bias} to analog ground at all times. Likewise, although V_{Ref} may only be used internally, a 0.1 μ F capacitor from the V_{Ref} pin to ground is required at all times. The analog ground reference point for these two capacitors must be physically the same point. To facilitate this the V_{Ref} and V_{Bias} pins are situated on adjacent pins.

The transmit filter is designed to meet CCITT G.714 specifications. The nominal gain for this filter path is 0 dB (gain control = 0 dB). Gain control allows the output signal to be increased up to 7 dB. An anti-aliasing filter is included. This is a second order lowpass implementation with a corner frequency at 25 kHz. Attenuation is better than 32 dB at 256 kHz and less than 0.01 dB within the passband.

An optional 400 Hz high-pass function may be included into the transmit path by enabling the Tfhp bit in the Control Register 1 (address 0Eh). This option allows the reduction of transmitted background noise such as motor and fan noise.



Figure 3 - Audio Gain Partitioning

The receive filter is designed to meet CCITT G.714 specifications. The nominal gain for this filter path is 0 dB (gain control = 0dB). Gain control allows the output signal to be attenuated up to 7 dB. Filter response is peaked to compensate for the sinx/x attenuation caused by the 8 kHz sampling rate.

The Rx filter function can be altered by enabling the Dial EN control bit in Control Register 1 (address 0Eh). This causes another low-pass function to be added with a 3 dB point at 1200 Hz. This function is intended to improve the sound quality of digitally generated dial tone received as PCM.

Side-tone is derived from the Tx filter before the LP/HP filter section and is not subject to the gain control of the Tx filter section. Side-tone is summed into the receive handset transducer driver path after the Rx filter gain control

section so that Rx gain adjustment will not affect side-tone levels. The side-tone path may be enabled/disabled with the Voice sidetone bit located in the Receive Path Control Register (address 13h).

Transmit and receive filter gains are controlled by the $TxFG_0$ - $TxFG_2$ and $RxFG_0$ - $RxFG_2$ control bits, respectively. These are located in the FCODEC Control Register 1 (address 0Ah). Transmit filter gain is adjustable from 0 dB to +7 dB and receive filter gain from 0 dB to -7 dB, both in 1 dB increments.

Side-tone filter gain is controlled by the STG_0 - STG_2 control bits located in the FCODEC Control Register 2 (address 0Bh). Side-tone gain is adjustable from -9.96 dB to +9.96 dB in 3.32 dB increments.

-9.96 dB to +9.96 dB in 3.32 dB increments.

Companding law selection for the Filter/CODEC is provided by the A/ μ companding control bit while the coding scheme is controlled by the sign-mag/CCITT control bit. Both of these reside in Control Register 2 (address 0Fh). Table 1 illustrates these choices.

Code	Sign/	CCITT (G.711)					
Coue	Magnitude	μ -Law	A-Law				
+ Full Scale	1111 1111	1000 0000	1010 1010				
+ Zero	1000 0000	1111 1111	1101 0101				
-Zero (quiet code)	0000 0000	0111 1111	0101 0101				
- Full Scale	0111 1111	0000 0000	0010 1010				
Table 1							

The Filter/CODEC autonull circuit ensures that transmit PCM will contain no more than ± 1 bit of offset due to internal circuitry.

Digital Gain and Tone Generation

The Digital gain and Tone generator block is located, functionally, between the serial FDI port and the Filter/CODEC block. Its main function is to provide digital gain control of the transmit and receive audio signals and to generate digital patterns for DTMF and tone ringer signals.

Gain Control

Gain control is performed on linear code for both the receive and the transmit PCM. Gain control is set via the Digital Gain Control Register at address 19h. Gain, in 3.0 dB increments, is available within a range of +21.0 dB to -24 dB.

DTMF Generator

The digital DTMF circuit generates a dual sine-wave pattern which may be routed into the receive path as comfort tones or into the transmit path as network signalling. In both cases the digitally generated signal will undergo gain adjustment as programmed into the transmit and receive gain control registers. Gain control is assigned automatically as functions are selected via the transmit and receive path control registers.

The composite signal output level in the transmit direction is -4 dBm0 (μ -Law) and -10 dBm0 (A-law) with programmable gains at zero dB. Pre-twist of 2.0 dB is incorporated into the composite signal resulting in a low tone output level of -8.12 dBm0 and a high group level of -6.12 dBm0 (for μ -Law, 6 dB lower for A-Law). Note that these levels will be influenced by the Anti-Howling circuit when it is enabled (see Anti-Howling section for more details). DTMF side-tone levels are set to -28 dBm0 from the generator circuit. Other receive path gains must be included when calculating the analog output signal levels. Adjustments to these levels may be made by altering the settings of the Gain Control register (address 19h).

The frequency of the low group tone is programmed by writing an 8-bit coefficient into the Low Tone Coefficient Register (address 1Ah) while the high group tone frequency uses the 8-bit coefficient programmed into the High Tone Coefficient Register (address 1Bh). Both coefficients are determined by the following equation:

Frequency (in Hz) = 7.8125 x COEFF

Where COEFF is an integer between 0 and 255. Frequency resolution is 7.8125 Hz in the range 0 to 1992 Hz.

Low and high tones are enabled individually via the LoEn and HiEN control bits (DTMF/Ringer Control Register, address 18h). This not only provides control over dual tone generation but also allows single tone generation using either of the enable bits and its associated coefficient register.

After programming and enabling the tone generators as described, selection of transmit and/or receive path destinations are carried out via the Path Control Registers (see Path Control section). In addition receive sidetone DTMF must be selected via the DTMF StEN bit (DTMF/Tone ringer Register, address 18h) so that it replaces the received PCM in the Rx Filter path.

Frequency (Hz)	COEFF	Actual Frequency	% Deviation
697	59h	695.3	20%
770	63h	773.4	+.40%
852	6Dh	851.6	05%
941	79h	945.3	+.46%
1209	9Bh	1210.9	+.20%
1336	ABh	1335.9	.00%
1477	BDh	1476.6	03%
1633	D1h	1632.8	01%

Table 2 - DTMF Frequencies

DTMF Signal to distortion:

The sum of harmonic and noise power in the frequency band from 50 Hz to 3500 Hz is typically more than 30 dB below the power in the tone pair. All individual harmonics are typically more than 40 dB below the level of the low group tone.

Table 2 gives the standard DTMF frequencies, the coefficient required to generate the closest frequency, the actual frequency generated and the percent deviation of the generated tone from the nominal.

Tone Ringer

A dual frequency squarewave ringing signal may be applied to the handsfree speaker driver to generate a call alerting signal. To enable this mode the Ring En bit (address 18h) must be set as well as the ringer function to the loudspeaker via the Receive Path Control Register (address 13h). Ring En is independent of the DTMF enable control bits (see Lo EN and Hi EN). Since both functions use the same coefficient registers they are not usually enabled simultaneously.

The digital tone generator uses the values programmed into the low and high Tone Coefficient Registers (addresses 1Ah and 1Bh) to generate two different squarewave frequencies.

Both coefficients are determined by the following equation:

COEFF = [32000/Frequency (Hz)] - 1

where COEFF is an integer between 1 and 255. This produces frequencies between 125 - 16000 Hz with a non-linear resolution.

The ringer program switches between these two frequencies at a 5 Hz or 10 Hz rate as selected by the WR bit in the DTMF/Tone ringer register (address 18h).

Anti-Howl

IDPC includes an Anti-Howling circuit plus speaker gain control circuit to allow for group listening operation. Although this is the main function of the circuit there are additional modes in which it may be used as defined by the MS1 and MS0 control bits (address 1Ch).

<u>MS1</u>	<u>MS0</u>	Operational Mode
0	0	Tx noise reduction (squelch)
0	1	Rx noise reduction (squelch)
1	0	switched loss group listening (anti-howling)
1	1	Tx/Rx switched loss

The circuit is enabled by setting the Anti-howl Enable bit (address 1Ch) and selecting the required operational mode (MS0 & MS1) as described.

For all modes of operation the switching levels and inserted loss are programmed as follows.

Switching decisions are made by comparing either the transmit or the receive signal level to threshold levels stored in the High Threshold Register (address 1Dh) and the Low Threshold Register (address 1Eh). Threshold data is encoded in PCM sign-magnitude format excluding the sign bit. For example; THh0 - THh3 encode the PCM step number while THh4 - THh6 encode the PCM chord number for the high threshold. Similarly for the THI0 - THI6 bits of the low threshold. The difference between the high and low threshold levels provides the circuit with hysteresis to prevent uncontrolled operation. The low level threshold must never be programmed to a value higher than the one stored in the high level threshold. If this occurs the circuit will become unstable.

Loss is implemented, in the chosen path, by subtracting the value set by the Pad0 - Pad3 control bits from the appropriate gain value set by the RxG0 - RxG3 or TxG0 - TxG3 control bits (see Digital Gain Register, address 19h). The minimum digital gain is limited to -24 dB regardless of the mathematical result of this operation. The path without loss reverts to the gain value programmed into the Digital Gain Register.

The magnitude of the switched loss defaults to 12 dB on power up but can be programmed to between 0 and 21 dB using the Pad0 - Pad2 control bits (address 1Ch).

Pad2	<u>Pad1</u>	<u>Pad0</u>	<u>Attenuation (dB)</u>
0	0	0	0
0	0	1	3
0	1	0	6
0	1	1	9
1	0	0	12
1	0	1	15
1	1	0	18
1	1	1	21

Switched Loss for Group Listening (anti-howling)

Group listening is defined as a normal handset conversation with received speech also directed to the loudspeaker for third party observation. In this mode, if the handset microphone is moved into close proximity of the loudspeaker a feedback path will occur resulting in a singing connection. To prevent this the anti-howling circuit introduces a switched loss into either the transmit or receive paths dependent upon the transmit path speech activity.

Loss switching is determined by comparing the signal level in the transmit path with the high level threshold stored at address 1Dh. When the transmit signal level exceeds this threshold the programmed loss is switched from the transmit path to the receive path. Once switching has occurred the transmit signal level is then compared to a low level threshold stored at address 1Eh. When the transmit signal level falls below this threshold the programmed loss is switched from the transmit signal level falls below this threshold the programmed loss is switched from the received path back to the transmit path and comparison reverts back to the high threshold level.

Since the received digital gain control is used to set the listening level of the received speech, for both handset receiver and loudspeaker, it is necessary to provide additional gain in the loudspeaker path so that its receive level can be controlled independently from the receiver output. The Gain0 to Gain3 control bits (address 0Bh) are used to boost the loudspeaker output to a comfortable listening level for the third parties in group listening. Generally the Gain3 bit should be set to logic 1 in this mode. This increases the gain programmed via the Gain0 - Gain2 bits by a factor of 8 dB. In group listening a speaker gain setting of 4 to 16 dB will be required to set a comfortable group listening level after the handset user has adjusted their listening level as required.

Since the anti-howling circuit has dynamic control over the transmit and receive gain control registers, it is recommended that this function be turned off momentarily when DTMF tone generation is required. This will ensure that the proper transmit levels are attained.

Transmit Noise Reduction (squelch)

The transmit signal may be muted to eliminate transmission of excessive background noise.

In this mode the signal level in the transmit path is compared with the high level threshold stored at address 1Dh. When the transmit signal level exceeds this threshold no loss is inserted into the transmit path. After exceeding the high level threshold the transmit signal level is then compared to a low level threshold stored at address 1Eh. When the transmit signal level falls below this threshold the transmit digital gain is reduced by the programmed amount (Pad0-2) and comparison reverts back to the high threshold level. The receive path gain is not altered by transmit noise reduction.

Receive Noise Reduction (squelch)

The receive signal may be muted to eliminate background noise resulting from a poor trunk connection.

In this mode the signal level in the receive path is compared with the high level threshold stored at address 1Dh. When the receive signal level exceeds this threshold no loss is inserted into the receive path. After exceeding the high level threshold the receive signal level is then compared to a low level threshold stored at address 1Eh. When the receive signal level falls below this threshold the receive digital gain is reduced by the programmed amount (Pad2-0) and comparison reverts back to the high threshold level. The transmit path gain is not altered by receive noise reduction.

Tx/Rx Switched Loss

In this mode the programmed switched loss is inserted into either the transmit or receive path dependent only upon activity in the receive path. If receive path activity is above the programmed high level threshold then the switched loss is inserted into the transmit path. If receive path activity is below the programmed low level threshold then the switched loss is inserted into the receive path.

This mode can be used to implement a loudspeaking function where the receive audio is routed to the SPKR± pins and transmit audio is sourced from the MIC+ pin. In this mode there is no algorithmic cancellation of echo so it is recommended that this switched loss program be used only in 4-wire systems (i.e., digital set to digital set).

Transducer Interfaces

Four standard telephony transducer interfaces plus an auxiliary I/O are provided by the IDPC. These are:

- The handset microphone inputs (transmitter), pins M+/M- and the answerback microphone input MIC+. The nominal transmit path gain may be adjusted to either 6.0 dB or 15.3 dB. Control of this gain is provided by the TxINC control bit (Control register 2, address 0Fh). This gain adjustment is in addition to the programmable gain provided by the transmit filter and Digital Gain circuit.
- The handset speaker outputs (receiver), pins HSPKR+/HSPKR-. This internally compensated, fully differential output driver is capable of driving the load shown in Figure 4. The nominal handset receive path gain may be adjusted to either -12.1 dB or -9.6 dB. Control of this gain is provided by the RxINC control bit (Control

register 2, address 0Fh). This gain adjustment is in addition to the programmable gain provided by the receive filter and Digital Gain circuit.

- The loudspeaker outputs, pins SPKR+/SPKR-. This internally compensated, fully differential output driver is capable of directly driving 6.5v p-p into a 40 ohm load.
- The Auxiliary Port provides an analog I/O, pins AUXin and AUXout, for connection of external equipment to the CODEC path as well as allowing access to the speaker driver circuits.
 - AUXin is a single ended high impedance input (>10 Kohm). This is a self-biased input with a maximum input range of 2.5vp-p. Signals should be capacitor-coupled to this input.
 - AUXout is a buffered output capable of driving 40 Kohms//150 pF. Signals for this output are derived from the receive path or from the AUXin and transmit microphones.
 - Auxiliary port path gains are:

AUXin to Dout	11 dB	TxINC=0
	20.3 dB	TxINC=1
Din to AUXout	-12 dB	
AUXin to AUXout	-7.0 dB	
AUXin to HSPKR±	-1.1 dB	RxINC=0
	1.4 dB	RxINC=1
AUXin to SPKR±	5.0 dB	

Refer to the application diagrams of Figures 10 and 11 for typical connections to this analog I/O section.



Figure 4 - Handset Speaker Driver

Microport

The serial microport, compatible with Intel MCS-51 (mode 0), Motorola SPI (CPOL=0,CPHA=0) and National Semiconductor Microwire specifications provides access to all IDPC internal read and write registers. This microport consists of a transmit/receive data pin (DATA1), a receive data pin (DATA2), a chip select pin (CS) and a synchronous data clock pin (SCLK).

The microport dynamically senses the state of the serial clock each time chip select becomes active. The device then automatically adjusts its internal timing and pin configuration to conform to Intel or Motorola/National requirements. If SCLK is high during chip select activation then Intel mode 0 timing is assumed. The DATA1 pin is defined as a bi-directional (transmit/receive) serial port and DATA2 is internally disconnected. If SCLK is low during chip select activation then Motorola/National timing is assumed. Motorola processor mode CPOL=0, CPHA=0 must be used. DATA1 is defined as the data transmit pin while DATA2 becomes the data receive pin. Although the dual

port Motorola controller configuration usually supports full-duplex communication, only half-duplex communication is possible in IDPC. The micro must discard non-valid data which it clocks in during a valid write transfer to IDPC. During a valid read transfer from IDPC data simultaneously clocked out by the micro is ignored by IDPC.

All data transfers through the microport are two-byte transfers requiring the transmission of a Command/Address byte followed by the data byte written or read from the addressed register. CS must remain asserted for the duration of this two-byte transfer. As shown in Figures 5 and 6 the falling edge of CS indicates to the IDPC that a microport transfer is about to begin. The first 8 clock cycles of SCLK after the falling edge of CS are always used to receive the Command/Address byte from the microcontroller. The Command/Address byte contains information detailing whether the second byte transfer will be a read or a write operation and at what address. The next 8 clock cycles are used to transfer the data byte between the IDPC and the microcontroller. At the end of the two-byte transfer CS is brought high again to terminate the session. The rising edge of CS will tri-state the output driver of DATA1 which will remain tri-stated as long as CS is high.

Intel processors utilize least significant bit first transmission while Motorola/National processors employ most significant bit first transmission. The IDPC microport automatically accommodates these two schemes for normal data bytes. However, to ensure timely decoding of the R/W and address information, the Command/Address byte is defined differently for Intel operation than it is for Motorola/National operation. Refer to the relative timing diagrams of Figures 5 and 6.

Receive data is sampled on the rising edge of SCLK while transmit data is made available concurrent with the falling edge of SCLK.

Detailed microport timing is shown in Figure 15.



Figure 5 - Serial Port Relative Timing for Intel Mode 0

COMMAND/ADDRESS © // DATA INPUT/OUTPUT	Image: Weight of the second							
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	$\begin{array}{c c} H \\ \hline \\ D_7 \end{array} \begin{array}{c} D_6 \end{array} \begin{array}{c} D_5 \end{array} \begin{array}{c} D_4 \end{array} \begin{array}{c} D_3 \end{array} \begin{array}{c} D_2 \end{array} \begin{array}{c} D_1 \end{array} \begin{array}{c} D_0 \end{array} \end{array}$							
DATA 1 TRANSMIT $D_7 D_6 D_5 D_4 D_3 D_2 D_1 D_0$	$\begin{array}{c c} & & \\ & &$							
 Delays due to internal processor timing which are transparent to IDPC. 								
² The IDPC:- latches received data on the rising edge of SCLK.								
 outputs transmit data on the falling edge of SCLK. The falling edge of CS indicates that a COMMAND/ADDRESS byte will be transmitted subsequent byte is always data until terminated via CS returning high. A new COMMAND/ADDRESS byte may be loaded only by CS cycling high then low age 								
© The COMMAND/ADDRESS byte contains: 1 bit - Read/Write 5 bits - Addressing Data 2 bits - Unused R/₩	$\begin{array}{c c c c c c c c c c c c c c c c c c c $							

Figure 6 - Serial Port Relative Timing for Motorola Mode 00/National Microwire



Figure 7 - ST-BUS Channel Assignment

Flexible Digital Interface

A serial link is required to transport data between the IDPC and an external digital transmission device. IDPC utilizes the ST-BUS architecture defined by Zarlink Semiconductor but also supports a strobed data interface found on many standard CODEC devices. This interface is commonly referred to as Synchronous Serial Interface (SSI). The combination of ST-BUS and SSI provides a Flexible Digital Interface (FDI) capable of supporting all Zarlink basic rate transmission devices as well as many other 2B + D transceivers.

The required mode of operation is selected via the ST-BUS/SSI control bit (FDI Control Register, address 10h). Pin definitions alter dependent upon the operational mode selected, as described in the following subsections as well as in the Pin Description tables.

Quiet Code

The FDI can be made to send quiet code to the decoder and receive filter path by setting the RxMUTE bit high. Likewise, the FDI will send quiet code in the transmit (DSTo) path when the TxMUTE bit is high. Both of these

control bits reside in Control Register 1 at address 0Eh. When either of these bits are low their respective paths function normally. The -Zero entry of Table 1 is used for the quiet code definition.

ST-BUS Mode

The ST-BUS consists of output (DSTo) and input (DSTi) serial data streams, in FDI these are named Dout and Din respectively, a synchronous clock input signal CLOCKin (C4i), and a framing pulse input (F0i). These signals are direct connections to the corresponding pins of Zarlink basic rate devices. Note that in ST-BUS mode the XSTL2 pin is not used. The CSL1 and CSL0 bits, as described in the SSI Mode section, are also ignored since the data rate is fixed for ST-BUS operation. However, the Asynch/Synch bit must be set to logic "0" for ST-BUS operation.

The data streams operate at 2048 kb/s and are Time Division Multiplexed into 32 identical channels of 64 kb/s bandwidth. A frame pulse (a 244 nSec low going pulse) is used to parse the continuous serial data streams into the 32 channel TDM frames. Each frame has a 125 μ Second period translating into an 8 kHz frame rate. A valid frame begins when F0i is logic low coincident with a falling edge of C4i. Refer to Figure 12 for detailed ST-BUS timing. C4i has a frequency (4096 kHz) which is twice the data rate. This clock is used to sample the data at the 3/4 bit-cell position on DSTi and to make data available on DSTo at the start of the bit-cell. C4i is also used to clock the IDPC internal functions (i.e., Filter/CODEC, Digital gain and tone generation) and to provide the channel timing requirements.

The IDPC uses only the first four channels of the 32 channel frame. These channels are always defined, beginning with Channel 0 after the frame pulse, as shown in Figure 7 (ST-BUS channel assignments).

The first two (D & C) Channels are enabled for use by the DEN and CEN bits respectively, (FDI Control Register, address 10h). ISDN basic rate service (2B+D) defines a 16kb/s signalling (D) Channel. IDPC supports transparent access to this signalling channel. ST-BUS basic rate transmission devices, which may not employ a microport, provide access to their internal control/status registers through the ST-BUS Control (C) Channel. IDPC supports microport access to this C-Channel.

DEN - D-Channel

In ST-BUS mode access to the D-Channel (transmit and receive) data is provided through an 8-bit read/write register (address 15h) D-Channel data is accumulated in, or transmitted from this register at the rate of 2 bits/frame for 16 kb/s operation (1 bit/frame for 8 kb/s operation). Since the ST-BUS is asynchronous, with respect to the microport, valid access to this register is controlled through the use of an interrupt (IRQ) output. D-Channel access is enabled via the (DEn) bit.

<u>DEn:</u>

When 1, ST-BUS D-channel data (1 or 2 bits/frame depending on the state of the D8 bit) is shifted into/out of the D-channel (READ/WRITE) register.

When 0, the receive D-channel data (READ) is still shifted into the proper register while the DSTo D-channel timeslot and IRQ outputs are tri-stated (default).

<u>D8:</u>

When 1, D-Channel data is shifted at the rate of 1 bit/frame (8 kb/s).

When 0, D-Channel data is shifted at the rate of 2 bits/frame (16 kb/s default).

16 kb/s D-Channel operation is the default mode which allows the microprocessor access to a full byte of D-Channel information every fourth ST-BUS frame. By arbitrarily assigning ST-BUS frame n as the reference frame, during which the microprocessor D-Channel read and write operations are performed, then:

A microport read of address 15 hex will result in a byte of data being extracted which is composed of four di-bits (designated by roman numerals I,II,III,IV). These di-bits are composed of the two D-Channel bits received during each of frames n, n-1, n-2 and n-3. Referring to Fig. 8a: di-bit I is mapped from frame n-3, di-bit II is mapped from frame n-2, di-bit III is mapped from frame n-1 and di-bit IV is mapped from frame n.

The D-Channel read register is not preset to any particular value on power-up (PWRST) or software reset (RST).

b. A microport write to Address 15hex will result in a byte of data being loaded which is composed of four dibits (designated by roman numerals I, II, III, IV). These di-bits are destined for the two D-Channel bits transmitted during each of frames n+1, n+2, n+3, n+4. Referring to Fig.8a: di-bit I is mapped to frame n+1, di-bit II is mapped to frame n+2, di bit III is mapped to frame n+3 and di bit IV is mapped to frame n+4.

If no new data is written to address 15hex, the current D-channel register contents will be continuously retransmitted. The D-Channel write register is preset to all ones on power-up (PWRST) or software reset (RST).

An interrupt output is provided (IRQ) to synchronize microprocessor access to the D-Channel register during valid ST-BUS periods only. IRQ will occur every fourth (eighth in 8 kb/s mode) ST-BUS frame at the beginning of the third (second in 8 kb/s mode) ST-BUS bit cell period. The interrupt will be removed following a microprocessor Read or Write of Address 15 hex or upon encountering the following frames's FP input, whichever occurs first. To ensure D-Channel data integrity, microport read/write access to Address 15 hex must occur before the following frame pulse. See Figure 8b for timing.

8 kb/s operation expands the interrupt to every eight frames and processes data one-bit-per-frame. D-Channel register data is mapped according to Figure 8c.



Figure 8a - D-Channel 16 kb/s Operation



Figure 8b - IRQ Timing Diagram



Figure 8c - D-Channel 8 kb/s Operation

CEn - C-Channel

Channel 1 conveys the control/status information for the layer 1 transceiver. C-Channel data is transferred MSB first on the ST-BUS by IDPC. The full 64 kb/s bandwidth is available and is assigned according to which transceiver is being used. Consult the data sheet for the selected transceiver for its C-Channel bit definitions and order of bit transfer.

When CEN is high, data written to the C-Channel register (address 14h) is transmitted, most significant bit first, on DSTo. On power-up reset (PWRST) or software reset (RST, address 0Fh) all C-Channel bits default to logic high. Receive C-Channel data (DSTi) is always routed to the read register regardless of this control bit's logic state.

When low, data transmission is halted and this timeslot is tri-stated on DSTo.

B1-Channel and B2-Channel

Channels 2 and 3 are the B1 and B2 channels, respectively. B-channel PCM associated with the Digital Gain, Filter/CODEC and transducer audio paths is selected on an independent basis for the transmit and receive paths. For example, the transmit path may use the B1 channel while the receive path uses the B2 channel. Although not normally required, this flexibility is allowed.

For ST-BUS mode the configuration of bits 0 to 3, at address 12h, defines both the source of transmit audio and the B-Channel destination. The configuration of this register permits selection of only one transmit B-Channel at a time. If no valid transmit path has been selected, via the Transmit Path Selection Register, for a particular B-Channel then that timeslot output on DSTo is tri-stated.

When a valid receive path has been selected, via the Receive Path Selection Register (address 13h), the active receive B-Channel is governed by the state of the B2/B1 control bit in Control register 1 (address 0Eh).

Refer to the Path Selection section for detailed information.

SSI Mode

The SSI BUS consists of input and output serial data streams named Din and Dout respectively, a Clock input signal (CLOCKin), and a framing strobe input (STB). A 4.096 MHz master clock, at CLOCKin, is required for SSI operation if the bit clock is less than 512 kHz. The timing requirements for SSI are shown in Figures 13 and 14.

In SSI mode the IDPC supports only B-Channel operation. The internal C and D Channel registers used in ST-BUS mode are not functional for SSI operation. The control bit B2/B1, as described in the ST-BUS section, is ignored since the B-Channel timeslot is defined by the input STB strobe. Hence, in SSI mode transmit and receive B-Channel data are always in the channel defined by the STB input.

The data strobe input STB determines the 8-bit timeslot used by the device for both transmit and receive data. This is an active high signal with an 8 kHz repetition rate.

SSI operation is separated into two categories based upon the serial data rate. If the bit clock is 512 kHz or greater then the bit clock is used directly by the internal IDPC functions allowing synchronous operation. In this case, the bit clock is connected directly to the CLOCKin pin while XSTAL2 is left unconnected. If the available bit clock rate is 128 kHz or 256 kHz then a 4096 kHz master clock is required to derive clocks for the internal IDPC functions. If this clock is available externally then it may be applied directly to the CLOCKin pin. If a 4096 kHz clock is not available then provision is made to connect a 4096 kHz crystal across the CLOCKin and XSTAL2 pins as shown in Figure 9. The oscillator circuit has been designed to require an external feedback resistor and load capacitors. This configuration allows normal ST-BUS operation and synchronous SSI operation with clocks which are not loaded by these extra components.



(for asynchronous operation)

Applications where the bit clock rate is below 512 kHz are designated as asynchronous. The IDPC will generate and re-align its internal clocks to allow operation when the external master and bit clocks are asynchronous. In this case, the external bit clock is not connected to the IDPC. Control bits Asynch/Synch, CSL1 and CSL0 in FDI Control Register (address 10h) are used to program the bit rates as shown in Table 3.

CSL1	CSL0	Bit Clock Rate (kHz)	CLOCKin (kHz)
0	0	128	4096 mandatory
0	1	256	4096 mandatory
0	0	512	512
0	1	1536	1536
1	0	2048	2048
1	1	4096	4096
	0 0 0	0 0 0 1 0 0 0 1 1 0	CSL1 CSL0 Rate (kHz) 0 0 128 0 1 256 0 0 512 0 1 1536 1 0 2048

Table 3

For synchronous operation data is sampled, from Din, on the falling edge of the bit clock during the time slot defined by the STB input. Data is made available, on Dout, on the rising edge of the bit clock during the time slot defined by the STB input. Dout is tri-stated at all times when STB is not true. If STB is valid but no transmit path has been selected (via the Transmit Path Control Register) then quiet code will be transmitted on Dout during the valid strobe period. There is no frame delay through the FDI circuit for synchronous operation.

For asynchronous operation Dout and Din are as defined for synchronous operation except that data is transferred according to the internally generated bit clock. Due to resynchronization circuitry activity, the output jitter on Dout is nominally larger but will not affect operation since the bit cell period at 128 kb/s and 256 kb/s is relatively large. There is a one frame delay through the FDI circuit for asynchronous operation. Refer to the specifications of Figures 13 and 14 for both synchronous and asynchronous SSI timing.

Path Selection

Transmit and receive audio paths are independently programmed through their respective Path Control Registers at addresses 12h and 13h. Individual audio path circuit blocks are powered up only as they are required to satisfy the programmed values in the path control registers. More detail is provided in the Power-up/down Reset section.

<u>Transmit</u>

Transmit audio path configuration (Path Control Register, address 12h) is simply a matter of assigning one of the three analog signal inputs, or the digital tone generator, to the required transmit B- Channel. Intermediate functions such as the transmit filter, encoder and transmit gain are automatically powered up and assigned as required. If transmit tones is selected then the digital tone generator must be programmed and enabled properly as described in the Digital Tone Generator section. Note that transmit tones may be enabled independently of the receive path.

For ST-BUS mode the configuration of bits 0 to 3, at address 12h, defines both the source of transmit audio and the B-Channel destination. The configuration of this register permits selection of only one transmit B-Channel at a time. For SSI mode only the selections where bit 3 = 0 are allowed. This is because the B-Channel timeslot is defined by the input strobe at STB. If a selection where bit 3 = 1 is made it will be treated the same as the condition where B3 - B0 = all zero's.

All reserved configurations should not be used.

Receive

The receive path assignment (Receive Path Control Register, address 13h) is different from the transmit path assignment. In this case a particular analog output port is assigned a source for its audio signal. The receive filter audio path and the Auxiliary In analog port are the available choices. This configuration allows flexibility in assignment. Two examples; the receive filter path can be assigned to the handset receiver, for a standard handset conversation, while permitting the loudspeaker to announce a message originating from the Auxiliary In port. Or

perhaps the receive filter is assigned to both the loudspeaker and the Auxiliary Out port. This would allow a voice recorder or Facsimile machine, connected to the AUXout port to be monitored over the loudspeaker.

The receive filter path itself has two possible signal sources, PCM from the Din port or synthesized tones, from the digital tone generator. In both cases receive digital gain is assigned automatically. The Receive Path Control Register combines all of these choices into simple output port assignments.

In ST-BUS mode receive PCM from the Din port must be selected from either the B1 or the B2 channel. Control Bit B2/B1 in Control Register 1 (address 0Eh) is used to define the active receive B-Channel. In SSI mode the active PCM channel is automatically defined by the STB input signal.

Sidetone

A voice sidetone path provides proportional transmit signal summing into the receive handset transducer driver. Details are provided in the Filter/CODEC section.

Watchdog

To maintain program integrity an on-chip watchdog timer is provided for connection to the microcontroller reset pin. The watchdog output WD goes high while the IDPC is held in reset via PWRST. Release of PWRST will cause WD to return low immediately and will also start the watchdog timer. The watchdog timer is clocked on the falling edge of STB/F0i and requires only this input, along with V_{DD}, for operation. Note that in SSI mode, if STB disappears the watchdog will stop clocking. This will not harm processor operation but there is no longer any protection provided.

If the watchdog reset word is written to the watchdog register (address 11h) after PWRST is released, but before the timeout period (T=512 mSec) expires, a reset of the timer results and WD will remain low. Thereafter, if the reset word is loaded correctly at intervals less than 'T' then WD will continue low. The first break from this routine, in which the watchdog register is not written to within the correct interval or it is written to with incorrect data, will result in a high going WD output after the current interval 'T' expires. WD will then toggle at this rate until the watchdog register is again written to correctly.

5-Bit Watchdog Reset Word

B7	B6	B5	B4	B 3	B2	B1	B0	
Х	Х	Х	0	1	0	1	0	
x=don't care								

Power-up/down & PWRST/Software Reset

While the IDPC is held in PWRST no device control or functionality is possible. While in software reset (RST=1, address 0Fh) only the microport and watchdog are functional. Software reset can only be removed by writing RST logic low or by the PWRST pin.

After Power-up reset (\overline{PWRST}) or software reset (RST) all control bits assume their default states; μ -Law functionality, usually 0 dB programmable gains and all sections of IDPC, except the microport and watchdog, into powered down states. This is the low power, stand-by condition. This includes:

- The receive output drive transducers. All transducer output drivers are powered down forcing the output signals into tri-state. Output drivers (handset, handsfree-speaker, AUXout) are powered up/down individually as required by the state of the programmed bits in the Receive Path Control Register (address 13h)
- The transmit and receive filters and CODEC. All clocks for this circuit block are disabled. The complete section is automatically powered up as required by the programmed bits in the Transmit and Receive Path Control registers (addresses 12h and 13h). Whenever all path control selections are off this section is powered down. The CODEC and transmit/ receive filters cannot be powered up individually.
- The VRef and VBias circuits. Reference and Bias voltage drivers are tri-stated during power down causing the voltage at the pins to float. This circuit block is automatically powered up/down as it is required by either the Filter/CODEC or the transducer driver circuits. Whenever all path control selections are off this section is powered down. If the AUXin path to (any combination of the) output transducer drivers is selected then the VRef/VBias circuit is powered up but the Filter/CODEC circuit is not.
- The FDI and oscillator circuits. After PWRST, the device assumes SSI operation with Dout tri-stated while
 there is no strobe active on STB. If a valid strobe is supplied to STB, then Dout will be active, during the
 defined channel, supplying quiet code as defined in Table 1. If the device is switched to ST-BUS operation
 following PWRST, the entire Dout stream will be tri-stated until an active transmit channel is programmed. As
 well, following PWRST, the oscillator circuit is disabled and all timing for the IDPC functional blocks is halted.
 A clock signal applied to the MCL pin is prevented from entering further into the IDPC when the
 Asynch/Synch bit is logic "1".

To power up the FDI and oscillator circuits the PD bit of Control Register 1 (address 0Eh) must be cleared.

To attain complete power-down from a normal operating condition, write all "0s" to the <u>Transmit</u> and Receive Path Control Registers (address 12h and 13h), set PD to logic 1 at address 0Eh, and Asynch/Synch to logic 1 at address 10h.

IDPC Register Map

00 • • 09	RESERVED								
0A	-	RxFG ₂	$RxFG_1$	$RxFG_0$	-	TxFG ₂	TxFG ₁	$TxFG_0$	FCodec Control 1
0B	Gain3	Gain2	Gain1	Gain0	-	STG ₂	STG ₁	STG_0	FCodec Control 2
0C				RES	ERVED-				
0D				RES	ERVED-				
0E	PD	Tfhp	DialEn	-	-	B2/B1	RxMute	TxMute	Control Register 1
0F	RST	-	A/ µ	Smag/ CCITT	RxINC	TxINC	-	-	Control Register 2
10	-	ST <u>-BU</u> S/ SSI	CEN	DEN	D ₈	Asynch/ Synch	CSL1	CSL ₀	FDI Control
11	-	-	-	W_4	W_3	W ₂	W ₁	W_0	Watchdog
12	-	-	-	-	b ₃	b ₂	b ₁	b ₀	Tx Path Control
13	b ₇	b ₆	b ₅	b ₄	b ₃	b ₂	b ₁	b ₀	Rx Path Control
14	b ₇	b ₆	b ₅	b ₄	b ₃	b ₂	b ₁	b ₀	C-Channel Register
15	D ₇	D ₆	D_5	D ₄	D_3	D ₂	D ₁	D ₀	D-Channel Register
16				RES	ERVED-				
17	-	-	Loop ₂	Loop ₁	-	-	-	-	Loopback Register
18	HiEN	LoEn	DTMF StEn	Ring En	-	-	-	WR	DTMF/Tone Ringer
19	TxG ₃	TxG ₂	TxG ₁	TxG ₀	RxG_3	RxG ₂	RxG_1	RxG_0	Digital Gain
1A	L ₇	L_6	L_5	L ₄	L_3	L ₂	L ₁	L ₀	Low Tone Coeff
1B	H ₇	H ₆	H_5	H ₄	H_3	H ₂	H ₁	H ₀	High Tone Coeff
1C	Enable	-	MS_1	MS ₀	-	Pad ₂	Pad ₁	Pad ₀	Anti-Howl Control
1D	-	TH _{h6}	$\mathrm{TH}_{\mathrm{h5}}$	TH _{h4}	$\mathrm{TH}_{\mathrm{h3}}$	$\mathrm{TH}_{\mathrm{h2}}$	TH _{h1}	$\mathrm{TH}_{\mathrm{h0}}$	High Threshold
1E	-	TH _{I6}	TH _{I5}	TH _{I4}	TH _{I3}	TH _{I2}	TH _{I1}	TH _{I0}	Low Threshold
1F • • 3F	RESERVED								

Register Summary

ADDRESSES = 00h to 09h ARE RESERVED

er Coo	lec Con	trol Reg	ister 1					ADDR	ESS = 0Ał	n WRITE/R	EAD VER
	-	RxFG ₂	RxFG ₁	RxFG ₀	-	TxFG ₂	TxFG ₁	TxFG ₀			eset Value X000
	7	6	5	4	3	2	1	0			
	eive Gain	Rx	FG ₂	RxFG₁	RxFG ₀] [.	Transmit G		TxFG ₂	TxFG₁	TxFG ₀
	ting (dB) lefault) 0		0	0	0		Setting (c (default)		0	0	0
	-1		0	0	1		1		0	0	1
	-2 -3		0 0	1	0		2 3		0 0	1	0
	-3 -4		1	0	0		4		1	0	0
	-5		1	0	1		5		1	0	1
	-6		1	1	0		6		1	1	0
	-7		1	1	1		7		1	1	1

	Gain3	Gain2	Gain1	Gain0	-	STG ₂	STG ₁	STG ₀		Power Res 0010 2	
Ŀ	7	6	5	4	3	2	1	0			
Speaker	· Gain (dl	B)					Side-tone	e Gain			
Gain3 = 1	Gaina	3 = 0	Gain2	Gain1	Gain0		Setting	(dB)	STG ₂	STG ₁	STG ₀
16	8		0	0	0		(default)	OFF	0	0	0
12	4		0	0	1		· -9.9		0	0	1
8	0		0	1	0		-6.6	4	0	1	0
4	-4	1	0	1	1		-3.3	2	0	1	1
0	-8	3	1	0	0		0		1	0	0
-4	-1	2	1	0	1		3.32	2	1	0	1
-8	-1	6	1	1	0		6.64	4	1	1	0
-12	-2	0	1	1	1		9.9	6	1	1	1

ADDRESS = 0Ch RESERVED

ADDRESS = 0Dh RESERVED

Control R	egister	1						ADDR	ESS = 0Eh WRITE/READ VERIFY
	PD	Tfhp	DialEN	-	-	B2/B1	RxMute	TxMute	Power Reset Value 100X X000
	7	6	5	4	3	2	1	0	-
PD	When	high, the	crystal osc	illator and	FDI block	s are powe	ered down.	. When low	v, the oscillator and FDI circuits are active.
Tfhp		-	additional ss filter is o		function (p	bassband	beginning	at 400 Hz) is inserted into the transmit path. When
DialEN	When disabl	0	st order lov	wpass filte	r is inserte	ed into the	receive pa	ath (3 dB =	1.2 kHz). When low, this lowpass filter is
B2/B1		0			•				w, the receive Filter/CODEC operates on and is ignored for SSI operation.
RxMUTE		0	received P en low the			•	•	with quiet	code; thus forcing the receive path into a
TxMUTE	mute	state (onl		ut code is	muted, th	ne transmi	•	•	code; thus forcing the output code into a ansmit Filter/CODEC are still functional).







Control bits b0 to b7 are used to assign a signal source individually to each receive path output. In addition transmit to receive voice sidetone path control is included.

Destination			Sou	rce Programming	
Handset Speaker	b ₁	b ₀			
	0	0	0	ff	
	Ő	1		x Filter	
	1	ò		UXin	
	1	1		eserved	
Handsfree Speaker	b ₃	b ₂			
	0	0	0	ff	
	Ő	1		x Filter	
	ĩ	ò		UXin	
	1	1		inger	
Aux out	b ₆	b ₅	b ₄		
	0	0	0	Off	
	0	0	1	Rx Filter	
	0	1	0	Reserved	
	0	1	1	AUXin	
	1	0	0	Handset mic (M+ /M -)	
	1	0	1	Handsfree mic (MIC +)	
	1	1	0	Reserved	
	1	1	1	Reserved	
Voice Sidetone	b ₇				
	0	Voice s	idetone i	bath disabled	
	1			bath enabled	



D-Channel Register ADDRESS = 15h WRITE/READ Power Reset Value 1111 1111 D6 D5 D4 D3 D2 D1 D0 D7 7 2 3 1 6 5 4 0

ADDRESS = 16h RESERVED

Loopba	ack Regist	er						ADDR	ESS = 17h WRITE/READ VERIFY
	-	-	Loop2	Loop1	-	-	-	-	Power Reset Value XX00 XXXX
	7	6	5	4	3	2	1	0	
Loop1									Receive Path selections) or the strobed
l oon1	When high	the selec	ted B-char	nel in ST.	ansmit and	Receive Path selections) or the stroked			
	B-channel looped bac	in SSI moo k. When lo	de is loope ow, the dev	d back fro /ice operat	m Din to E es normal	out throug ly.	h the FDI	block. The	C & D channels (ST-BUS mode) are not
Loop1 Loop2	B-channel looped bac When high be used if	in SSI moo k. When lo , Loop1 is PCM resid	de is loope ow, the dev invoked wi es in the B	d back fro vice operat ith the tran 3-channel.	m Din to E es normal smit and r If a data p	Dout throug ly. eceive dig eattern is b	gh the FDI ital gain ao eing loope	block. The djustment b d back the	
	B-channel looped bac When high be used if that the tra	in SSI moo k. When lo , Loop1 is PCM resid nsmit and	de is loope ow, the dev invoked wi es in the B	ed back fro vice operat ith the tran 8-channel. gital gain re	m Din to E es normal smit and r If a data p egisters ar	Dout throug ly. eceive dig attern is b re set to 0c	gh the FDI ital gain ao eing loope	block. The djustment b d back the	C & D channels (ST-BUS mode) are not being included. This loopback should only n use Loop1 or use Loop2 after ensuring
Loop2	B-channel looped bac When high be used if that the tra 1) do no	in SSI mod k. When lo , Loop1 is PCM resid nsmit and ot enable L	de is loope ow, the dev invoked wi es in the B receive dig	ed back fro vice operat ith the tran B-channel. gital gain re Loop2 sime	m Din to E es normal smit and r If a data p egisters ar ultaneousl	Dout throug ly. eceive dig battern is b re set to 0c y.	gh the FDI ital gain ac eing loope IB (addres	block. The djustment k ed back the s 19h). Wh	C & D channels (ST-BUS mode) are not being included. This loopback should only n use Loop1 or use Loop2 after ensuring



Digital Gain Register

ADDRESS = 19h WRITE/READ VERIFY

Power Reset Value 1000 1000

TxG ₃	TxG ₂	TxG ₁	TxG ₀	RxG ₃	RxG ₂	RxG ₁	RxG ₀
7	6	5	4	3	2	1	0

Transmit (TxG₃₋₀) and receive (RxG₃₋₀) control bits for programming gain in 3 dB increments.

RxG_3	RxG ₂	RxG ₁	RxG ₀	Gain Adjustment (dB)	TxG ₃	TxG ₂	TxG ₁	TxG ₀
0	0	0	0	-24	0	0	0	0
0	0	0	1	-21	0	0	0	1
0	0	1	0	-18	0	0	1	0
0	0	1	1	-15	0	0	1	1
0	1	0	0	-12	0	1	0	0
0	1	0	1	-9	0	1	0	1
0	1	1	0	-6	0	1	1	0
0	1	1	1	-3	0	1	1	1
1	0	0	0	0	1	0	0	0
1	0	0	1	+3	1	0	0	1
1	0	1	0	+6	1	0	1	0
1	0	1	1	+9	1	0	1	1
1	1	0	0	+12	1	1	0	0
1	1	0	1	+15	1	1	0	1
1	1	1	0	+18	1	1	1	0
1	1	1	1	+21	1	1	1	1

Low Tone	Coeffic	ient Re	gister			ADDRESS = 1Ah WRITE/READ VERIFY			
	L7	L6	L5	L4	L3	L2	L1	LO	Power Reset Value 0000 0000
	7	6	5	4	3	2	1	0	-
The frequen equation:	icy of the lo	ow group t	one is prog	grammed b	by writing a	an 8-bit he	kadecimal	coefficient	t at this address according to the following
				Freq	uency (in	Hz) = 7.8	125 x COI	EFF	
Where the h 0 to 1992 H		al COEFF	is convert	ed into a d	lecimal int	eger betwe	een 0 and	255. Freq	uency resolution is 7.8125Hz in the range

High Ton	e Coeffic	ient Re	gister					ADDR	ESS = 1Bh WRITE/READ VERIFY
	H7	H6	H5	H4	H3	H2	H1	H0	Power Reset Value 0000 0000
	7	6	5	4	3	2	1	0	-
The freque following ec		high grou	ip tone is	programm	ned by wri	iting an 8-	bit hexad	ecimal coe	efficient at this address according to the
				Freq	uency (in	Hz) = 7.8	125 x COI	EFF	
		•	•		ned by wri	U			efficient at this address according to the

Where the hexadecimal COEFF is converted into a decimal integer between 0 and 255. Frequency resolution is 7.8125Hz in the range 0 to 1992 Hz.

nti-How	I Control	Regist	er					ADDRE	SS = 1Ch WRITE/READ VERIF
	Enable	-	MS1	MS0	-	Pad2	Pad1	Pad0	Power Reset Value 0X10 X100
Enable	7 When	6 high, the	5 anti-howlii	4 ng circuit is	3 s enabled.	2 When low	1 , the anti-ł	0 nowling cire	cuit is disabled.
MS1, MS0		•		node of the vling circui		ling circui	t as follow	s. Details	of each mode are found in the function
	MS1	MS0	Oper	ational M	ode				
	0	0	Tran	smit Noise	Squelch				
	0	1	Rece	eive Noise	Squelch				
	1	0	Anti-	howling fo	r group list	tening			
	1	1	Tx/R	x Switched	l Loss				
Pad2-0				ttenuation the defaul		ch will be	switched i	nto the trai	nsmit or receive paths by the anti-howlir
	Pad2	Pa	d1 l	Pad0	At	tenuation	(dB)		
	0	()	0		0			
	0	()	1		3			
	0		1	0		6			
	0		1	1		9			
	1	()	0		12			
	1	()	1		15			
	1		1	0		18			
	1		1	1		21			

High Thre	eshold R	egister						ADDR	ADDRESS = 1Dh WRITE/READ VERIFY		
	-	THh6	THh5	THh4	THh3	THh2	THh1	THh0	Power Reset Value X011 0000		
	7	6	5	4	3	2	1	0			
THh6-0				•	0			•	CM sign-magnitude excluding the sign bit. umber. The default setting of 'X011 0000'		

encodes chord 3 step 0. The difference between the high and low thresholds defines the hysteresis for anti-howling.

Low Thre	shold R	egister						ADDR	ESS = 1Eh WRITE/READ VERIFY
	-	THI6	THI5	THI4	THI3	THI2	THI1	THI0	Power Reset Value X001 0100
	7	6	5	4	3	2	1	0	-
THI6-0	THI0 - 1	THI3 enco	de the ste	p number	while THI	4 - THI6 e	ncode the	e chord nu	CM sign-magnitude excluding the sign bit. mber. The default setting of 'X001 0100' fines the hysteresis for anti-howling.
			•			0		ADDRE	ESSES 1Fh to 3Fh are RESERVE

Applications



Figure 10 - ST-BUS Application Circuit with MT8972 (DNIC)



Figure 11 - SSI Application Circuit showing Synchronous or Asynchronous Operation

Programming Examples

Some examples of the programming steps required to set-up various telephony functions are given. Note that these steps are from the power-up reset default definition. If some other state is currently true then some programming steps may be omitted while new ones may be required.

Initialization		
Description	<u>Address</u>	DATA
choose ST-BUS vs SSI (ie ST-BUS with C&D channels enabled) or (ie SSI at 256kHz BCL)	10h 10h	70h 05h
power up oscillator and FDI same as above with B2 channel for ST-BUS	0Eh 0Eh	00h (other bits as required) 04h (other bits as required)
A-Law vs μ-Law as required (ie CCITT μ-Law and gains low) or (ie CCITT A-Law and gains increased)	0Fh 0Fh	00h (default value so no write required) 2Ch
Standard Full-duplex handset call		
Description	<u>Address</u>	DATA
program Initialization steps above		
set sidetone gain (ie 0 dB) set gain (ie Rx = +3 dB, Tx = 0 dB)	0Bh 19h	04h (leave speaker gain defaulted to 0dB) 89h (or as required, defaults = 0dB)
select transmit path (ie handset mic to B2 for ST-BUS) or (ie handset mic for SSI)	12h 12h	09h 01h
select receive path (ie handset speaker to Rx filter plus sidetone) or (as above plus receive to AUXout also)	13h 13h	81h (for standard headset only) 91h
optional: set Filter/CODEC Rx and Tx gain	0Ah	as required (0dB default)
Group Listening		
Description	<u>Address</u>	DATA
program Initialization steps above		
set gain (ie Rx = +3 dB, Tx = 0 dB)	19h	89h (or as required, defaults = 0dB)
set sidetone gain (ie 0 dB) and also set handsfree speaker gain independent of the rest of the receive path (ie 12dB)	0Bh	94h
set high threshold level set low threshold level	1Dh 1Eh	as required or leave default value as required or leave default value
enable group listening with 12dB of atten.	1Ch	A4h
select transmit path (ie handset mic to B2 for ST-BUS) or (ie handset mic for SSI)	12h 12h	09h 01h
select receive path (ie Rx filter to both handset and handsfree speakers with sidetone)	13h	85h

Generate tone ringer		
Description	Address	DATA
Program Initialization steps above except A-Law	vs μ-Law choic	es are not required.
set speaker gain (ie -12dB)	0Bh	50h (or as required)
write low tone coefficient	1Ah	as required
write high tone coefficient	1Bh	as required
select ringer as source for loudspeaker	13h	0Ch
start tone ringer (warble = 5Hz) or (warble = 10Hz)	18h 18h	11h 10h (default)
control ringer cadence by toggling	18h	10h (on)
Ring EN (ie warble = 10Hz)	1011	00h (off) 10h (on) 00h (off) etc
Generate DTMF tones transmit only		
Description	<u>Address</u>	DATA
Program Initialization steps above		
set Tx digital gain (ie 0 dB) (-4dBm0/μ-Law,-10dBm0/A-Law)	19h	80h (or as required)
write low tone coefficient	1Ah	as required
write high tone coefficient	1Bh	as required
select transmit path (ie Tx tones to B2 for ST-BUS)	12h	0Ch
or (ie Tx tones for SSI)	12h	04h
start DTMF	18h	C0h (both Hi EN and Lo EN)
or for single tones	18h	80h òr 40h as required
DTMF sidetones only		
Description	Address	DATA
Program Initialization steps above set Rx digital gain (ie 0 dB) (-28dBm0)	19h	08h (or as required)
write low tone coefficient	1Ah	as required
write high tone coefficient	1Bh	as required
select receive path	4.01-	041
(ie Rx Filter to handset) or (ie Rx Filter to handsfree speaker)	13h 13h	01h 04h
or (ie Rx Filter to AUX out)	13h	10h
start DTMF program with sidetone	18h	E0h (both Hi EN and Lo EN)
or for single tones	18h	A0h or 60h as required
DTMF transmit and sidetone		
Description	<u>Address</u>	DATA
Program Initialization steps above		
set Tx digital gain (ie 0 dB)	19h	88h (or as required)
(-4dBm0/μ-Law,-10dBm0/A-Law) set Rx digital gain (ie 0 dB) (-28dBm0)		
write low tone coefficient	1Ah	as required
write high tone coefficient	1Bh	as required
select transmit path		
(ie Tx tones to B2 for ST-BUS)	12h	0Ch
or (ie Tx tones for SSI) select receive path	12h	04h
(ie Rx Filter to handset)	13h	01h
or (ie Rx Filter to handsfree speaker)	13h	04h
or (ie Rx Filter to AUX out)	13h	10h
start DTMF program with sidetone or for single tones	18h 18h	E0h (both Hi EN and LO EN) A0h or 60h as required
	1011	AND OF OUT as required

Absolute Maximum Ratings

	Parameter	Symbol	Min.	Max.	Units	
1	Supply Voltage		V_{DD} - V_{SS}	- 0.3	7	V
2	Voltage on any I/O pin		V _I /V _O	V _{SS} - 0.3	V _{DD} + 0.3	V
3	Current on any I/O pin (transducers excluded)		I _I /I _O		± 20	mA
4	Storage Temperature		Τ _S	- 65	+ 150	°C
5	Power Dissipation (package)	Plastic	P _D		750	mW

Recommended Operating Conditions - Voltages are with respect to V_{SS} unless otherwise stated

	Characteristics	Sym.	Min.	Тур.	Max.	Units	Test Conditions
1	Supply Voltage	V _{DD}	4.75	5	5.25	V	
2	TTL Input Voltage (high)*	V _{IHT}	2.4		V _{DD}	V	Includes Noise margin = 400 mV
3	TTL Input Voltage (low)*	V _{ILT}	V_{SS}		0.4	V	Includes Noise margin = 400 mV
4	CMOS Input Voltage (high)	V _{IHC}	4.5		V _{DD}	V	
5	CMOS Input Voltage (low)	V _{ILC}	V_{SS}		0.5	V	
6	Operating Temperature	T _A	- 40		+ 85	°C	

* Excluding PWRST which is a Schmitt Trigger Input.

Power Characteristics

	Characteristics	Sym.	Min.	Тур.	Max.	Units	Test Conditions
1	Supply Current (clock disabled, all functions off, P _D =1)	I _{DDC1}		400		μΑ	Outputs unloaded, Input signals static, not loaded
2	Supply Current by function: Filter/Codec Digital Gain/Tone Handset Driver (bias only, no signal) Speaker Driver (bias only, no signal) Timing Control, C-channel, ST-BUS, etc. Total all functions enabled	I _{DDF1} I _{DDF2} I _{DDF3} I _{DDF4} I _{DDF5} I _{DDFT}		1.5 1.5 1.25 1.25 1.0 14.0	19.0	mA mA mA mA mA	See Note 1. See Note 1. See Notes 1 & 2.

Note 1: Power delivered to the load is in addition to the bias current requirements.

Note 2: I_{DDFT} is not additive to I_{DDC1} .

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Input HIGH Voltage TTL inputs	V _{IHT}	2.0			V	
2	Input LOW Voltage TTL inputs	V _{ILT}			0.8	V	
3	Input HIGH Voltage CMOS inputs	V _{IHC}	3.5			V	
4	Input LOW Voltage CMOS inputs	V _{ILC}			1.5	V	
5	VBias Voltage Output	V _{Bias}		V _{DD} /2		V	Max. Load = $10k\Omega$
6	Input Leakage Current	I _{IZ}		0.1	10	μΑ	$V_{IN}=V_{DD}$ to V_{SS}
7	Positive <u>Going</u> Threshold Voltage (PWRST only) Negative <u>Going</u> Threshold Voltage (PWRST only)	V _{T+} V _{T-}	3.7		1.3	V V	
8	Output HIGH Current	I _{OH}	- 5	- 16		mA	V _{OH} = 2.4V
9	Output LOW Current	I _{OL}	5	10		mA	$V_{OL} = 0.4V$
10	Output Reference Voltage	V _{Ref}		V _{DD} /2-1.5		V	No load
11	Output Leakage Current	I _{OZ}		0.01	10	μΑ	$V_{OUT} = V_{DD}$ and V_{SS}
12	Output Capacitance	Co		15		pF	
13	Input Capacitance	Ci		10		pF	

DC Electrical Characteristics[†] - Voltages are with respect to ground (V_{SS}) unless otherwise stated.

DC Electrical Characteristics are over recommended temperature range & recommended power supply voltages.
 Typical figures are at 25 °C and are for design aid only: not guaranteed and not subject to production testing.

CLOCKin Tolerance Characteristics

	Characteristics	Min.	Typ.‡	Max.	Units	Test Conditions
1	CLOCKin (C4i) Frequency	4095.6	4096	4096.4	kHz	

† AC Electrical Characteristics are over recommended temperature range & recommended power supply voltages.

‡ Typical figures are at 25 °C and are for design aid only: not guaranteed and not subject to production testing.

Preferred Crystal Characteristics

Nominal Frequency Frequency Tolerance	4096 kHz ±100 ppm @25°C
Operating Temperature	-40°C to +85°C
Shunt Capacitance	7pF Maximum
Drive Level	5 mW
Series Resistance	130 Ω maximum
Load Capacitance	20 pF
Frequency Stability	±0.003%/°C from 25°C

AC Characteristics[†] for A/D (Transmit) Path - 0dBm0 = $1.421V_{rms}$ for μ -Law and $1.477V_{rms}$ for A-Law, at the CODEC. (V_{Ref} =1.0 volts and V_{Bias} =2.5 volts.)

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Analog input equivalent to overload decision	A _{Li3.17} A _{Li3.14}		5.79 6.0		Vp-р Vp-р	μ-Law A-Law Both at CODEC
2	Absolute half-channel gain $M \pm to PCM$	G _{AX1}	5.0	6.0	7.0	dB	Transmit filter gain=0dB setting. Digital gain=0dB setting. TxINC = 0*
	MIC + to PCM	G _{AX2} G _{AX3}	14.3 9.5	15.3 11	16.3 12.5	dB dB	$TxINC = 1^*$ $TxINC = 0^*$
	AUXin to PCM	G _{AX4} G _{AX5}	18.8 9.5	20.3 11	21.8 12.5	dB dB	$TxINC = 1^*$ $TxINC = 0^*$
		G _{AX6}	18.8	20.3	21.8	dB	TxINC = 1* @1020 Hz
	Tolerance at all other transmit filter settings (1 to 7dB)		-0.2		+0.2	dB	
3	Gain tracking vs. input level CCITT G.714 Method 2	G _{TX}	-0.3 -0.6 -1.6		0.3 0.6 1.6	dB dB dB	3 to -40 dBm0 -40 to -50 dBm0 -50 to -55 dBm0
4	Signal to total Distortion vs. input level CCITT G.714 Method 2	D _{QX}	35 29 24			dB dB dB	0 to -30 dBm0 -40 dBm0 -45 dBm0
5	Transmit Idle Channel Noise	N _{CX} N _{PX}		15 -71	16.5 -69	dBrnC0 dBm0p	μ-Law A-Law
6	Gain relative to gain at 1020Hz <50Hz 60Hz 200Hz 300 - 3000 Hz 3000 - 3400 Hz 4000 Hz >4600 Hz	G _{RX}	-0.25 -0.9		-25 -30 0.0 0.25 0.25 -12.5 -25	dB dB dB dB dB dB dB	
7	Absolute Delay	D _{AX}		360		μs	at frequency of minimum delay
8	Group Delay relative to D _{AX}	D _{DX}		750 380 130 750		μs μs μs μs	500-600 Hz 600 - 1000 Hz 1000 - 2600 Hz 2600 - 2800 Hz
9	Power Supply Rejection f=1020 Hz f=0.3 to 3 kHz f=3 to 4 kHz f=4 to 50 kHz Electrical Characteristics are over recomme	PSSR PSSR1 PSSR2 PSSR3	37 40 35 40			dB dB dB dB	100mVRMS V _{DD} μ-law PSSR1-3 not production tested

AC Electrical Characteristics are over recommended temperature range & recommended power supply voltages.
Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.
Note: TxINC, refer to Control Register 2, address 0Fh.

AC Characteristics[†] for D/A (Receive) Path - 0dBm0 = $1.421V_{rms}$ for μ -Law and $1.477V_{rms}$ for A-Law, at the CODEC. (V_{Ref} =1.0 volts and V_{Bias} =2.5 volts.)

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Analog output at the CODEC full scale	A _{Lo3.17} A _{Lo3.14}		5.704 5.906		Vр-р Vр-р	μ-Law A-Law
2	Absolute half-channel gain PCM to HSPKR± PCM to SPKR± PCM to AUXout	G _{AR1} G _{AR2} G _{AR3} G _{AR4}	-13.1 -10.6 -1.0 -14	-12.1 -9.6 0 -12	-11.1 -8.6 1.0 -10	dB dB dB dB	Receive filter gain = 0dB setting. Digital gain = 0dB setting. RxINC = 0* RxINC = 1* @ 1020 Hz
	Tolerance at all other receive filter settings (-1 to -7dB)		-0.2		+0.2	dB	
3	Gain tracking vs. input level CCITT G.714 Method 2	G _{TR}	-0.3 -0.6 -1.6		0.3 0.6 1.6	dB dB dB	3 to -40 dBm0 -40 to -50 dBm0 -50 to -55 dBm0
4	Signal to total distortion vs. input level CCITT G.714 Method 2	G _{QR}	35 29 24			dB dB dB	0 to -30 dBm0 -40 dBm0 -45 dBm0
5	Receive Idle Channel Noise	N _{CR} N _{PR}		13 -78.5	15.5 -77	dBrnC0 dBm0p	μ-Law A-Law
6	Gain relative to gain at 1020Hz 200Hz 300 - 3000 Hz 3000 - 3400 Hz 4000 Hz >4600 Hz	G _{RR}	-0.25 -0.90		0.25 0.25 0.25 -12.5 -25	dB dB dB dB dB	
7	Absolute Delay	D _{AR}		240		μs	at frequency of min. delay
8	Group Delay relative to D _{AR}	D _{DR}		750 380 130 750		μs μs μs μs	500-600 Hz 600 - 1000 Hz 1000 - 2600 Hz 2600 - 2800 Hz
9	Crosstalk D/A to A/D A/D to D/A	CT _{RT} CT _{TR}			-74 -80	dB dB	G.714.16

AC Electrical Characteristics are over recommended temperature range & recommended power supply voltages.
Typical figures are at 25 °C and are for design aid only: not guaranteed and not subject to production testing.
* Note: RxINC, refer to Control Register 2, address 0Fh.

AC Electrical Characteristics[†] for Side-tone Path

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Absolute path gain Gain adjust = 0dB	G _{AS1} G _{AS2}	-17.2 -14.7	-16.7 -14.2	-16.2 -13.7	dB dB	TxINC, RxINC both 0* TxINC, RxINC both 1* M± inputs to HSPKR± outputs 1000 Hz
	All other settings (-9.96 to +9.96dB)	G _{AS} G _{AS}	-0.3 -0.3		+0.3 +0.3	dB dB	SIDEA/ <u>u</u> =0 SIDEA/u=1 from nominal relative measurements w.r.t. G _{AS1} & G _{AS2}

† AC Electrical Characteristics are over recommended temperature range & recommended power supply voltages.

Typical figures are at 25 °C and are for design aid only: not guaranteed and not subject to production testing.
 * Note: RxINC and TxINC, refer to Control Register 2, address 0Fh.

AC Characteristics[†] for Auxiliary Analog LoopbackPath

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Absolute gain for analog loopback from Auxiliary port.						
	AUXin to HSPKR±	G _{AA1} G _{AA2}	-3.1 -0.6	-1.1 1.4	0.9 3.4	dB dB	RxINC = 0* RxINC = 1*
	AUXin to SPKR±	G _{AA3}	3.0	5.0	7.0	dB	
	AUXin to AUXout	G _{AA4}	-9	-7	-5	dB	@1020 Hz

† AC Electrical Characteristics are over recommended temperature range & recommended power supply voltages.

Typical figures are at 25 °C and are for design aid only: not guaranteed and not subject to production testing.
 Note: RVINC refer to Control Design aid only: not guaranteed and not subject to production testing.

Note: RxINC, refer to Control Register 2, address 0Fh.

AC Electrical Characteristics[†] for Ringer Tone

	Characteristics	Sym.	Typ.‡	Units		Test C	onditions
1	Ringer Tone Output voltage (SPKR+ to SPKR-)	V _{R0} V _{R-4} V _{R-8} V _{R-12} V _{R-16} V _{R-20} V _{R-24} V _{R-28}	6.0 3.79 2.39 1.51 951 600 379 239	Vp-p Vp-p Vp-p mVp-p mVp-p mVp-p mVp-p	<u>Gain2</u> 0 0 0 1 1 1 5 Gain3 = Ioad>3	-	<u>Gain0</u> 0 1 0 1 0 1 0 1 cross SPKR±

† AC Electrical Characteristics are over recommended temperature range & recommended power supply voltages.

‡ Typical figures are at 25 °C and are for design aid only: not guaranteed and not subject to production testing.

Electrical Characteristics[†] for Analog Outputs

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Earpiece load impedance	E _{ZL}	260	300		ohms	across HSPKR±
2	Allowable Earpiece capacitive load	E _{CL}		300		pF	each pin: HSPKR+, HSPKR-
3	Earpiece harmonic distortion	E _D			0.5	%	300 ohms load across HSPKR \pm (tol-15%), VO \leq 693mV _{RMS} , RxINC=1*, Rx gain=0dB
4	Speaker load impedance	S _{ZL}	34	40		ohms	across SPKR±
5	Allowable Speaker capacitive load	S _{CL}		300		pF	each pin SPKR+, SPKR-
6	Speaker harmonic distortion	S _D			0.5	%	40 ohms load across SPKR± (tol-15%), VO \leq 6.2Vp-p, Rx gain=0dB

† Electrical Characteristics are over recommended temperature range & recommended power supply voltages.
 ‡ Typical figures are at 25 °C and are for design aid only: not guaranteed and not subject to production testing.
 * Note: RxINC, refer to Control Register 2, address 0Fh.

Electrical Characteristics[†] for Analog Inputs

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Input voltage without overloading CODEC						
	at MIC+	V _{IOLM}		1.63 0.580		Vр-р Vр-р	$\begin{array}{l} TxINC=0,A/\overline{\mu}=0^{*}\\ TxINC=1,A/\mu=1^{*} \end{array}$
	at AUXin	V _{IOLA}		1.63 0.580		Vр-р Vр-р	TxINC = 1, $A/\overline{\mu} = 0^*$ TxINC = 1, $A/\overline{\mu} = 1^*$
	across M+/M-	V _{IOLH}		2.90 1.03		Vр-р Vр-р	TxINC = 0, $A/\underline{\mu}$ = 0* TxINC = 1, A/μ = 1*
							Tx filter gain=0dB setting
2	Input impedance	Z _I Z _{IA}	50 10			kΩ kΩ	M+/M-, MIC+ AUXin to V _{SS}

† Electrical Characteristics are over recommended temperature range & recommended power supply voltages.
 ‡ Typical figures are at 25 °C and are for design aid only: not guaranteed and not subject to production testing.
 * Note: TxINC and A/µ and refer to Control Register 2, address 0Fh.

AC Electrical Characteristics[†] - ST-BUS Timing (See Figure 12)

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	C4i Clock Period	t _{C4P}		244		ns	
2	C4i Clock High period	t _{C4H}		122		ns	
3	C4i Clock Low period	t _{C4L}		122		ns	
4	C4i Clock Transition Time	t _T		20		ns	
5	F0i Frame Pulse Setup Time	t _{F0iS}	50			ns	
6	F0i Frame Pulse Hold Time	t _{F0iH}	50			ns	
7	DSTo Delay	t _{DSToD}		100	125	ns	$C_L = 50 pF$, 1k Ω load.*
8	DSTi Setup Time	t _{DSTiS}	30			ns	
9	DSTi Hold Time	t _{DSTiH}	30			ns	

† Timing is over recommended temperature range & recommended power supply voltages.
 ‡ Typical figures are at 25 °C and are for design aid only: not guaranteed and not subject to production testing.
 * Note: All conditions → data-data, data-HiZ, HiZ-data.



Figure 12 - ST-BUS Timing Diagram

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	BCL Clock Period	t _{BCL}	244		1953	ns	BCL=4096 kHz to 512 kHz
2	BCL Pulse Width High	t _{BCLH}		122		ns	BCL=4096 kHz
3	BCL Pulse Width Low	t _{BCLL}		122		ns	BCL=4096 kHz
4	BCL Rise/Fall Time	t _R /t _F		20		ns	Note 1
5	Strobe Pulse Width	t _{ENW}		8 x t _{BCL}		ns	Note 1
6	Strobe setup time before BCL falling	t _{SSS}	80		t _{BCL} -80	ns	
7	Strobe hold time after BCL falling	t _{SSH}	80		t _{BCL} -80	ns	
8	Dout High Impedance to Active Low from Strobe rising	t _{DOZL}			90	ns	С _L =150 рF, R _L =1К
9	Dout High Impedance to Active High from Strobe rising	t _{DOZH}			90	ns	C _L =150 pF, R _L =1K
10	Dout Active Low to High Impedance from Strobe falling	t _{DOLZ}			90	ns	C _L =150 pF, R _L =1K
11	Dout Active High to High Impedance from Strobe falling	t _{DOHZ}			90	ns	C _L =150 pF, R _L =1K
12	Dout Delay (high and low) from BCL rising	t _{DD}			90	ns	С _L =150 рF
13	Din Setup time before BCL falling	t _{DIS}	50			ns	
14	Din Hold Time from BCL falling	t _{DIH}	50			ns	

† Timing is over recommended temperature range & recommended power supply voltages.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.
NOTE 1: Not production tested, guaranteed by design.





	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Bit Cell Period	T _{DATA}		7812 3906		ns ns	BCL=128 kHz BCL=256 kHz
2	Frame Jitter	Tj			600	ns	
3	Bit 1 Dout Delay from STB going high	t _{dda1}			T _j +600	ns	C _L =150 pF, R _L =1K
4	Bit 2 Dout Delay from STB going high	t _{dda2}	600+ Т _{DATA} -Т _j	600+ Т _{DATA}	600 + T _{DATA} +T _j	ns	C _L =150 pF, R _L =1K
5	Bit n Dout Delay from STB going high	t _{ddan}	600 + (n-1) x T _{DATA} -T _j	600 + (n-1) x T _{DATA}	600 + (n-1) x T _{DATA} +T _j	ns	C _L =150 pF, R _L =1K n=3 to 8
6	Bit 1 Data Boundary	T _{DATA1}	T _{DATA} -T _j		T _{DATA} +T _j	ns	
7	Din Bit n Data Setup time from STB rising	t _{SU}	T _{DATA} \2 +500ns-T _j +(n-1) x T _{DATA}			ns	n=1-8
8	Din Data Hold time from STB rising	t _{ho}	T _{DATA} \2 +500ns+T _j +(n-1) x T _{DATA}			ns	

AC Electrical Characteristics[†] - SSI BUS Asynchronous Timing (note 1) (see Figure 14)

† Timing is over recommended temperature range & recommended power supply voltages.
 ‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.
 NOTE 1: Not production tested, guaranteed by design.





	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	Input data setup	t _{IDS}	100			ns	
2	Input data hold	t _{IDH}	30			ns	
3	Output data delay	t _{ODD}			100	ns	$C_{L} = 150 \text{pF}, R_{L} = 1 \text{K}^{*}$
4	Serial clock period	t _{CYC}	500	1000		ns	
5	SCLK pulse width high	t _{CH}	250	500		ns	
6	SCLK pulse width low	t _{CL}	250	500		ns	
7	CS setup-Intel	t _{CSSI}	200			ns	
8	CS setup-Motorola	t _{CSSM}	100			ns	
9	CS hold	t _{CSH}	100			ns	
10	CS to output high impedance	t _{OHZ}			100	ns	C _L = 150pF, R _L = 1K

AC Electrical Characteristics[†] - Microport Timing (see Figure 15)

† Timing is over recommended temperature range & recommended power supply voltages.
‡ Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.
* Note: All conditions → data-data, data-HiZ, HiZ-data.



Figure 15 - Serial Microport Timing Diagram



Notes:

- 1. The chamfer on the body is optional. If it not present, a visual index feature, e.g. a dot, must be located within the cross-hatched area.
- 2. Controlling dimension are in millimeters.
- Dimension D do not include mould flash, protrusion or gate burrs. These shall not exceed 0.006" per side.
 Dimension E1 do not include inter-lead flash or protrusion. These shall not exceed 0.010" per side.
- 5. Dimension b does not include dambar protrusion/intrusion. Allowable dambar protrusion shall be 0.004" total in excess of b dimension.

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ISSUE	1	2	3		Previous package codes	Package Outline for
ACN	6746	201943	213100	SEMICONDUCTOR	MP/S	28 lead SOIC (0.300" Body Width)
DATE	7Apr95	27Feb97	15Jul02	JEMICONDUCTOR	/	
APPRD.						GPD00017





Notes:

- 2. Dimensions D1 and E1 do not include mould protrusions. Allowable mould protrusion is 0.010" per side. Dimensions D1 and E1 include mould protrusion mismatch and are determined at the parting line, that is D1 and E1 are measured at the extreme material condition at the upper or lower parting line.
- 3. Controlling dimensions in Inches.
- 4. "N" is the number of terminals.
- 5. Not To Scale
- 6. Dimension R required for 120° minimum bend.

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ISSUE	1	2	3		Previous package codes	Package Outline for
ACN	5958	207469	212422			28 lead PLCC
DATE	15Aug94	10Sep99	22Mar02			
APPRD.						GPD00002

2.11

1.42

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^{1.} All dimensions and tolerances conform to ANSI Y14.5M-1982



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